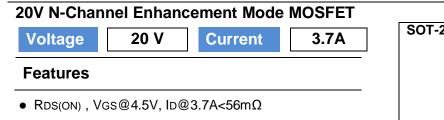
| PAN | JIT               |
|-----|-------------------|
|     | SEMI<br>CONDUCTOR |

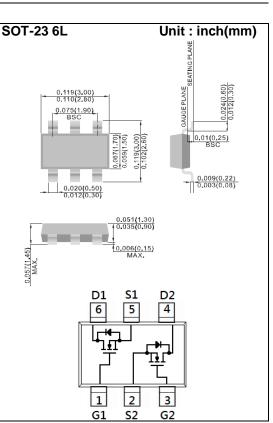




- RDS(ON) , VGS@2.5V, ID@2.8A<69mΩ
- Rds(ON) , Vgs@1.8V, Id@1.5A<98mΩ
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

#### **Mechanical Data**

- Case: SOT-23 6L Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0005 ounces, 0.014 grams
- Marking: SE2



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

| PARAMETER   |                      | SYMBOL                           | LIMIT   | UNITS |
|---|----------------------|----------------------------------|---------|-------|
| Drain-Source Voltage  |                      | V <sub>DS</sub>                  | 20      | V     |
| Gate-Source Voltage   | V <sub>GS</sub>      | <u>+</u> 12                      | V       |       |
| Continuous Drain Current  |                      | I <sub>D</sub>                   | 3.7     | А     |
| Pulsed Drain Current  |                      | I <sub>DM</sub>                  | 14.8    | А     |
| Power Dissipation   | T <sub>a</sub> =25°C | P <sub>D</sub>                   | 1.25    | W     |
|   | Derate above 25°C    |                                  | 10      | mW/°C |
| Operating Junction and Storage Temperature Range                        |                      | T <sub>J</sub> ,T <sub>STG</sub> | -55~150 | °C    |
| Typical Thermal resistance<br>- Junction to Ambient <sup>(Note 3)</sup> |                      | R <sub>θJA</sub>                 | 100     | °C/W  |



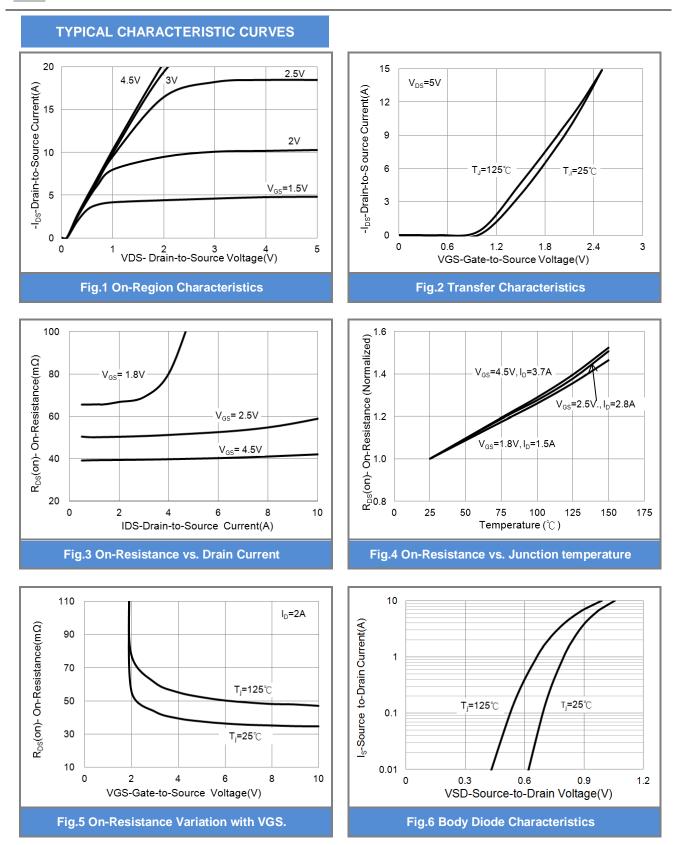
## **Electrical Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

| PARAMETER  | SYMBOL              | TEST CONDITION   | MIN. | TYP.        | MAX.         | UNITS |
|--|---------------------|--|------|-------------|--------------|-------|
| Static   | ſ                   | 1  | T    | 1           | I            | 1     |
| Drain-Source Breakdown Voltage                           | BV <sub>DSS</sub>   | $V_{GS}$ =0V, $I_{D}$ =250uA   | 20   | -           | -            | V     |
| Gate Threshold Voltage                                   | V <sub>GS(th)</sub> | $V_{DS}=V_{GS}$ , $I_{D}=250$ uA   | 0.4  | 0.67        | 1.2          | V     |
| Drain-Source On-State Resistance                         | R <sub>DS(on)</sub> | V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.7A  | -    | 41          | 56           | mΩ    |
|  |                     | $V_{GS}$ =2.5V, $I_{D}$ =2.8A  | -    | 51          | 69           |       |
|  |                     | V <sub>GS</sub> =1.8V, I <sub>D</sub> =1.5A  | -    | 69          | 98           |       |
| Zero Gate Voltage Drain Current                          | I <sub>DSS</sub>    | $V_{DS}$ =20V, $V_{GS}$ =0V  | -    | -0.01       | 1            | uA    |
| Gate-Source Leakage Current                              | I <sub>GSS</sub>    | V <sub>GS</sub> = <u>+</u> 12V, V <sub>DS</sub> =0V  | -    | <u>+</u> 10 | <u>+</u> 100 | nA    |
| Dynamic  |                     |  |      |             |              |       |
| Total Gate Charge  | $Q_g$               | V <sub>DS</sub> =10V, I <sub>D</sub> =3.7A,<br>V <sub>GS</sub> =4.5V <sup>(Note 1,2)</sup> | -    | 4.57        | -            | nC    |
| Gate-Source Charge                                       | $Q_gs$              |  | -    | 0.77        | -            |       |
| Gate-Drain Charge  | $Q_gd$              |  | -    | 0.98        | -            |       |
| Input Capacitance  | Ciss                | V <sub>DS</sub> =10V, V <sub>GS</sub> =0V,   | -    | 350         | -            | pF    |
| Output Capacitance                                       | Coss                |  | -    | 40          | -            |       |
| Reverse Transfer Capacitance                             | Crss                | f=1.0MHZ   | -    | 29.3        | -            |       |
| Switching  |                     |  |      |             |              |       |
| Turn-On Delay Time                                       | td <sub>(on)</sub>  |  | -    | 3.4         | -            | ns    |
| Turn-On Rise Time  | tr                  | $V_{DD}=10V, I_{D}=3.7A,$<br>$V_{GS}=4.5V,$  | -    | 47          | -            |       |
| Turn-Off Delay Time                                      | td <sub>(off)</sub> |  | -    | 18          | -            |       |
| Turn-Off Fall Time                                       | tf                  | $R_G=6\Omega^{(Note 1,2)}$   | -    | 10          | -            |       |
| Drain-Source Diode                                       |                     |  |      |             |              |       |
| Maximum Continuous Drain-Source<br>Diode Forward Current | I <sub>S</sub>      |  | -    | -           | 1.5          | А     |
| Diode Forward Voltage                                    | $V_{SD}$            | I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V  | -    | 0.75        | 1.2          | V     |

NOTES :

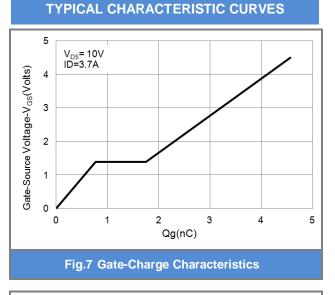
- 1. Pulse width<300us, Duty cycle<2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper
- 4. The maximum current rating is package limited





SEMI CONDUCTOR

PANJ



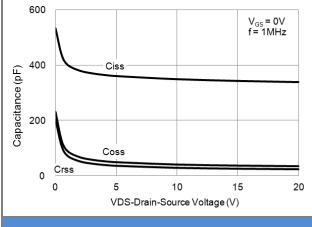
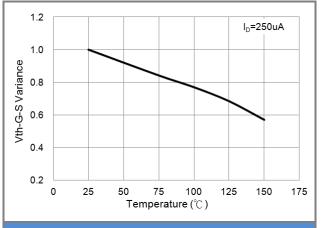


Fig.9 Capacitance vs. Drain-Source Voltage.







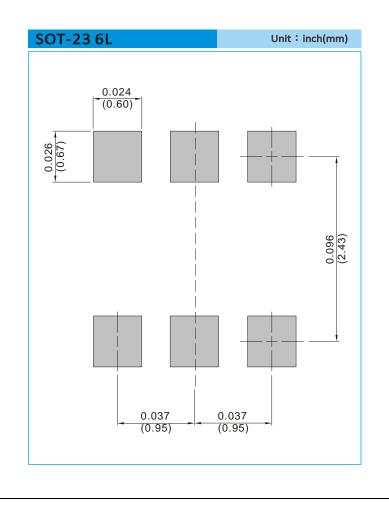




### PART NO PACKING CODE VERSION

| Part No Packing Code | Package Type | Packing type       | Marking | Version      |
|----------------------|--------------|--------------------|---------|--------------|
| PJS6812_S1_00001     | SOT-23 6L    | 3K pcs / 7" reel   | SE2     | Halogen free |
| PJS6812_S2_00001     | SOT-23 6L    | 10K pcs / 13" reel | SE2     | Halogen free |

### MOUNTING PAD LAYOUT





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